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7 High-Performance Perovskite Single-Junction and
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11 Textured Perovskite/Silicon Tandem Solar Cells via
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20 *Anand S. Subbiah^{†1}*, Furkan H. Isikgor^{†1}, Calvyn T. Howells¹, Michele De Bastiani¹, Jiang*
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24 *Liu¹, Erkan Aydin¹, Francesco Furlan¹, Thomas G. Allen¹, Fuzong Xu¹, Shynggys*
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27 *Zhumagali¹, Sjoerd Hoogland^{2,3}, Edward H. Sargent³, Iain McCulloch¹ and Stefaan De*
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31 *Wolf^{†1}**
32
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34

35 ¹KAUST Solar Center (KSC), Division of Physical Sciences and Engineering (PSE), King
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37
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39 Abdullah University of Science and Technology (KAUST), Thuwal, 23955-6900, Saudi
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43 Arabia.
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46
47 ²QD Solar Inc., MaRS Center, 661 University Ave, Toronto, Ontario, M5G 1M1, Canada.
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51
52 ³Department of Electrical and Computer Engineering, University of Toronto, Toronto,
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55 Ontario M5S 1A4, Canada.
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Corresponding Author

*Email: anand.subbiah@kaust.edu.sa; stefaan.dewolf@kaust.edu.sa

†Both authors contributed equally to this work.

ABSTRACT

In this work we report perovskite solar cells in the planar *p-i-n* configuration based on single-step, anti-solvent free, low-temperature (70 °C) slot-die coated methylammonium lead tri-iodide (MAPbI₃). The devices are fabricated on hydrophobic PTAA surfaces, using key strategies such as solvent engineering, enhanced ink-substrate dynamics, and surface passivation, enabling a power conversion efficiency (PCE) of 21.8%. We also adapted the technique to achieve the first slot-die coated perovskite/silicon monolithic 2-terminal tandems, achieving a PCE of 23.8% utilizing a textured silicon bottom cell.

TOC GRAPHICS

The remarkable progress of hybrid organic-inorganic perovskite solar cells (PSCs) has been enabled by spin-coating of the perovskite absorber, to date.¹ However, the technique is widely considered unsuitable for mass manufacturing. Indeed, the successful commercialization of PSCs demands high-throughput, scalable fabrication techniques with minimal operational expenditure and production costs,² thereby motivating the

translation of this technology to industrially-relevant deposition techniques.³ In addition to the progress made using vacuum-processed techniques towards large-area devices and modules⁴, various scalable perovskite solution-processing techniques such as blade-coating, slot-die coating, spray-coating, and ink-jet printing have also gathered considerable attention recently.^{5, 6} Among these techniques, slot-die coating offers significant advantages in terms of throughput, material utilization, scalability, and the ability to be integrated with sheet-to-sheet and roll-to-roll systems on an industrial level.^{7,}

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Recent efforts also aim at integrating perovskites with crystalline silicon (c-Si) as two-terminal (2T), monolithic tandem solar cells, with the reported tandem PCEs making progress towards exceeding the single-junction crystalline-silicon (c-Si) efficiency limit.^{9,}

¹⁰ Therefore, a scalable perovskite fabrication technique, compatible with integration into a c-Si based tandem cell offers significant advantages towards commercialization. To this effect, we sought to develop efficient PSCs using a one-step slot-die coating technique,

with the aim of translating the process to the fabrication of slot-die coated monolithic perovskite/silicon tandem devices on textured c-Si bottom cells.

To date, small-area ($\sim 0.1 \text{ cm}^2$) single-junction slot-die coated PSCs have resulted in PCEs of 18%,^{8, 11} but this is still appreciably below the performance of spin-coated devices. Notably, most of these slot-die based PSCs employ the classic *n-i-p* device configuration, with binary metal oxides (SnO_2 , TiO_2 , ZnO) as the electron transport layer (ETL).^{8, 11-14} Even though recent efforts promise low-temperature process methodologies for these metal oxides,¹⁵⁻¹⁷ a major hurdle for the scalability of *n-i-p* PSCs is the lack of suitable alternatives to the expensive spiro-OMeTAD (2,2',7,7'-tetrakis[N,N-di(4-methoxyphenyl)amino]-9,9'-spirobifluorene) hole transport layer (HTL). However, low-temperature processed organic charge transport layers, as already used for organic light-emitting diode fabrication, may be of higher commercial relevance. For the inverted *p-i-n* device configuration, slot-die coated PSCs reported in the literature typically employ PEDOT:PSS (poly(3,4-ethylenedioxythiophene) polystyrene sulfonate) as the HTL, resulting in only modest PCEs.¹⁸⁻²⁰ In contrast, for spin-coated PSCs in the *p-i-n*

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3 configuration, poly(triarylamine) (PTAA) is most commonly used as an HTL, enabling
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7 efficient devices.²¹ Despite the demonstrated gain in performance from PTAA on spin-
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10 coated devices,²² no report has utilized PTAA for slot-die coated PSCs.⁷ This is due to
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13 non-uniform perovskite thin-film formation on the hydrophobic PTAA surface, which
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17 hinders the wetting by conventional perovskite inks (mostly based on N, N-
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20 dimethylformamide (DMF) as solvent). Also, the absence of a centrifugal force, inherent
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23 to spin-coating, makes slot-die coating of hydrophilic perovskite inks on hydrophobic
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27 PTAA substrates a challenge.²² Interestingly, recent studies of surfactant-additives
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30 facilitated highly-efficient *p-i-n* devices on PTAA substrates via blade coating at elevated
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39 Herein we realize efficient single-step slot-die coated *p-i-n* PSCs with hydrophobic
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42 PTAA as the HTL (Scheme 1a), via a combination of three key strategies, namely solvent
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45 engineering, surfactant additives for improved ink-wetting, and interface passivation. The
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49 ink-substrate kinetics, the properties of solvents influencing the drying process, and the
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53 crystallization rate are key enablers to achieve high-quality slot-die coated PSCs. Firstly,
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we translate the MAPbI₃ precursor ink from the conventional DMF solvent towards low-boiling point acetonitrile (ACN) with the addition of a methylamine (dissolved in methanol) (MA(MeOH)) mixture.^{24, 25} The use of ACN+MA(MeOH) solvent system dramatically alters the fluid drying dynamics, ensuring swift evaporation of the solvent. Secondly, we incorporate a surfactant, L- α -phosphatidylcholine (LP, Fig. S1), as an additive that leads to better wettability and ink-substrate interaction on hydrophobic PTAA substrates, as reported earlier for DMF-based precursor inks.²² Thirdly, we passivate the MAPbI₃ perovskite surface using cysteine hydrochloride (Cys. HCl, Fig.S1) to minimize open-circuit voltage (V_{OC}) losses. Scheme 1b depicts the inverted *p-i-n* device structure (ITO-PTAA-MAPbI₃(Cys.HCl)-C₆₀-BCP-Cu) used in this study. The fabrication of the slot-die coated PSCs are described in detail in the experimental section (see SI).

One successful approach to ink development for scalable processing involves replacing polar aprotic solvents with ACN, aided by dissolved MA gas.^{24, 25} Moving away from the widely used DMF-based precursor inks allows a reduction in substrate temperature from ~150 °C to as low as ~ 70 °C, which is critical to ensure rapid

crystallization without anti-solvent extraction. We further improve the ease of ink-preparation by using commercially available MA in methanol (~9.8 mol/l) with ACN resulting in a stable MAPbI₃ precursor ink. Figure 1a shows the MAPbI₃ precursor ink with different volume ratios of ACN:MA(MeOH) (0:10 to 10:0) used to dissolve 1.1 M of methylammonium iodide (MAI) and lead iodide (PbI₂) precursor salts. Earlier studies dissolve methylamine gas in ACN to form the precursor ink with ACN acting as a primary channel to dissolve the MA⁺PbI₃⁻•xMA perovskite liquid phase. With the use of commercial MA(MeOH), we dissolve the 1.1 M precursor salts using an optimized volume ratio of 600μl:400μl (ACN:MA(MeOH)), resulting in a stable, clear solution. Also, higher volumes of MA(MeOH) adversely impact the precursor ink, forming milky dispersions as the presence of polar aprotic ACN is essential to dissolve the precursor constituents. The MAPbI₃(ACN+MA(MeOH)) precursor ink is subsequently modified by adding small quantities of LP additive. Figure 1b illustrates the individual components of the precursor ink used for the one-step slot-die coating of MAPbI₃ thin films in this study. The optimization of ACN:MA(MeOH) volume ratio (6:4) and LP additive concentration (0.075%

wt of MAPbI₃) are carried out separately via PSCs made by the blade-coating of MAPbI₃, and the corresponding values are adapted for slot-die coating here.

For the planar *p-i-n* PSC configuration in this study, firstly, the hydrophobic PTAA layer is coated on glass-ITO substrates via meniscus-coating. Figures 1c-e compare the contact-angles formed by MAPbI₃(DMF+LP), MAPbI₃(ACN+MA(MeOH)), and MAPbI₃(ACN+MA(MeOH)+LP) inks with the hydrophobic PTAA surface, respectively. Even though the MAPbI₃(DMF+LP) ink is known to produce efficient PSCs, the reduction in surface tension is evident from the lower contact-angle made by the MAPbI₃(ACN+MA(MeOH)) ink with the hydrophobic surface, even without the LP additive. The addition of LP further reduces the contact-angle of MAPbI₃(ACN+MA(MeOH)) ink with the PTAA substrate, resulting in a better wettability, and uniform perovskite films. Scanning electron microscope (SEM) images reveal the contrast in the MAPbI₃ film quality using the three different inks (Fig. S2a-c). Slot-die coated MAPbI₃ films based on the (ACN+MA(MeOH)+LP) ink demonstrates improved grain size with seemingly spherulitic domains (Fig. S3a) over DMF+LP and ACN+MA(MeOH) inks. Figure S4 shows

atomic force microscopy (AFM) images of slot-die coated MAPbI₃ films without and with the LP additive using ACN+MA(MeOH) inks. The incorporation of LP leads to more uniform films, evidenced by the greatly reduced the root-mean-square (RMS) roughness determined by AFM (Fig. S4). Notably, for DMF+LP inks, the slot-die coating is carried out at 140 °C, whereas for the other two inks, the substrate is only at 70 °C. Figure S2d and S3b illustrate the top-surface SEM image of the MAPbI₃ thin films after an interface passivation treatment with blade-coated Cys.HCl (dissolved in IPA). The presence of chlorine allows for the recrystallization of the grains, slightly improving their size (compare Fig. S2c and S2d) and this is also evident from the x-ray diffraction (XRD) measurements (Fig. S5). Despite the increase in grain size, the Cys.HCl treated films exhibit a reduced RMS roughness (Fig. S4). We expect the -COOH, -NH₂ and -SH functional groups of the cysteine molecule to passivate the non-coordinated Pb²⁺ and I⁻ defect states, leading to efficient charge collection.²⁶ Photoluminescence (PL) intensity and time-resolved PL (TRPL) measurements highlight the substantial improvements in minority carrier lifetime of the MAPbI₃ absorber with the addition of LP, followed by Cys.HCl treatment (Fig. S6 and Table S1). The cysteine passivated samples exhibited an average carrier lifetime

(τ_{avg}) of 1.6 μs , whereas the pristine samples and samples with the LP additive only have a τ_{avg} of 88 ns and 757 ns respectively. The PL emission of MAPbI₃ samples slot-die coated on top of the PTAA HTL is significantly quenched in comparison to the pristine samples.

Figure 2a compares the champion J - V curves of one-step slot-die coated MAPbI₃ PSCs employing the device architecture in scheme 1b for three different conditions: using the ACN+MA(MeOH) solvent precursor; using the ACN+MA(MeOH) solvent with LP additive; and using the ACN+MA(MeOH) solvent with the LP additive followed by Cys.HCl surface treatment via blade coating. The ACN+MA(MeOH) based MAPbI₃ control devices (active area $\sim 0.1 \text{ cm}^2$) exhibit a champion PCE of 18.1% (Fig. 2a) with an average value of $16.2 \pm 2.1\%$ (Fig. S7 and Table S2). Adding optimized concentrations of LP additives with the ACN+MA(MeOH) precursor ink resulted in an improvement in PCE with a champion value of 20.1% (average value $\sim 18.9 \pm 0.5\%$). The major improvement in the champion device parameters compared to the LP-free devices are in V_{OC} (1.02 V to 1.05 V) and fill factor (FF , 75.0% to 80.6%). We also observe a similar trend for the average

parameter values calculated from a batch of 18 devices each (Fig. S7 and Table S2). Two parameters that require a significant balance for slot-die coating are the coating speed and the ink supply rate. Coupled with the printhead-substrate distance, they play a crucial role in MAPbI₃ film thickness control, its coverage and their RMS roughness (Fig. S8). A step-wise variation of the parameter space resulted in an optimal slot-die head speed of 15 mm.s⁻¹ and an ink-supply rate of 400 µl.min⁻¹. Figure S9-S12 and Table S3-S4 illustrate the distribution of device parameter statistics and the champion *J-V* curves with varying slot-die coating parameters of slot-die head speed and ink-supply rate.

Surface passivation of LP-based MAPbI₃ thin films using blade-coated Cys.HCl (dissolved in IPA) further enhanced the V_{OC} of slot-die coated *p-i-n* devices by 40 mV on average. The surface-passivated slot-die PSCs exhibit a champion PCE of 20.8% (20.3±0.36%) (Fig. 2a and 2c) with a V_{OC} of 1.09 V (1.09±0.01 V), short-circuit current density, J_{SC} of 23.53 mA/cm² (23.18±0.36 mA/cm²) and *FF* of 80.9% (80.77±0.9%) (Fig. S7 and Table S2). The addition of LP and the introduction of Cys.HCl results in an overall systematic improvement in device parameter distribution for the slot-die coated PSCs

(Fig. 2c and S7). These devices set a benchmark for efficient slot-die coated small-area PSCs and demonstrate the promise of this technique. Introducing a textured anti-reflective foil (ARF) on the glass superstrate results in a champion slot-die coated PSC with a PCE of 21.8% (Fig. 2b). The enhancement in J_{SC} for the ARF coated device is attributed to the reduced reflectance of the entire device stack (Fig. S13a). Figure S13b shows the corresponding improvement in external quantum efficiency (EQE) measurements. Figure 2d shows the evolution of the maximum power point (MPP) tracked over 600 seconds with the passivated PSCs exhibiting significantly better stability in comparison to ACN+MA(MeOH) ink-based control samples.

Figure 3a shows the variation in EQE spectra for the average slot-die coated devices fabricated using the different techniques discussed here. The integrated J_{SC} values calculated from the EQE measurements align well with the average J_{SC} values measured using $J-V$ measurements for these devices. The most significant improvement in EQE is seen for a wavelength range of 650-800 nm for devices with the LP additive followed by Cys.HCl passivation. This suggests an enhancement in MAPbI₃ absorber

quality, as observed earlier from PL, TRPL, and SEM measurements, resulting in efficient charge-collection. Figure 3b shows the space-charge limited current (SCLC) measurements for the slot-die coated PSCs. The decrease in onset voltage (V_{TFL}) of the trap-filled limit (TFL; a regime wherein the trap-states are filled by the injected carriers) indicates a reduced trap-density in Cys.HCl treated devices in comparison with the other two devices. The trap-densities of slot-die coated MAPbI₃ *p-i-n* PSCs based on ACN+MA(MeOH), ACN+MA(MeOH)+LP, and ACN+MA(MeOH)+LP+Cys.HCl processes are estimated to be 1.8×10^{15} , 8.6×10^{14} , and $5.6 \times 10^{14} \text{ cm}^{-3}$, respectively. The improvement in device parameters for Cys.HCl treated devices is consistent with a decrease in the trap-density estimates. Making use of the slot-die coating technique, we fabricated mini-modules with an active area of 6.8 cm^2 (4 sub-cells with individual area of 1.7 cm^2) with an actual J_{SC} of 20.53 mA.cm^{-2} (actual current 34.9 mA and for PCE calculations we use $\sim 5.13 \text{ mA.cm}^{-2}$ ($\sim 34.9 \text{ mA}/6.8 \text{ cm}^2$)), V_{OC} of 4.05 V, FF of 0.695 leading to a PCE of 14.4%. Figure S14 summarizes the champion JV curves of the slot-die coated mini-module with device parameter distribution of 9 devices.

Recent progress on perovskite/silicon tandem devices using solution-processing on textured silicon bottom cells motivates the extension of our technique towards obtaining efficient slot-die coated tandems.^{27, 28} Here, we employ a textured silicon heterojunction bottom cell (as reported by Hou *et al.*,²⁷) with the perovskite absorber layer deposited by slot-die coating, using the ACN+MA(MeOH)+LP based precursor ink followed by Cys.HCl passivation. As in our single-junction PSCs, the polarity of the tandem device is in the *p-i-n* configuration. The bandgap of the absorber material is tuned by incorporating bromine ($\text{MAPb}(\text{I}_{0.75}\text{Br}_{0.25})_3$) to ensure a perovskite bandgap of 1.68 eV, required for current-matching. Figures S15-S17 illustrate the UV-vis absorption measurements, SEM top-surface and XRD pattern of slot-die coated ($\text{MAPb}(\text{I}_{0.75}\text{Br}_{0.25})_3$) films using the different conditions elucidated earlier. Figures S18-19 summarizes the performance of the corresponding slot-die coated single junction devices for the wide-bandgap absorber. Figures 4a and 4b represent the device schematic and SEM cross-section of the optimized tandem, respectively. Figure 4c illustrates the variation of PCE with slot-die coating speed to achieve optimized perovskite/silicon tandems. At a lower slot-die head-speed of 5 mm.s^{-1} , a thick perovskite layer is coated on top of the textured

Si bottom cell, resulting in inefficient charge-collection and performance losses. Relatively higher coating speeds (10-15 mm.s⁻¹) yielded uncovered Si pyramids with shunt paths that adversely affected the tandem devices. Figure S20 shows the cross-section SEM images of perovskite/silicon tandems for different slot-die coating speeds. The tandem devices fabricated with an optimized head-speed of 7.5 mm.s⁻¹ achieves a better device performance due to the uniform perovskite coverage on top of the Si pyramids over a large area (Fig. S21). Figure S22 illustrates the distribution of tandem device parameter statistics for the different process conditions with significant variations arising from V_{OC} and FF . Figure 4d shows the J - V curve of the champion device (active area ~1 cm²) exhibiting a PCE of 23.8% (stabilized MPP ~ 24.05%) with a V_{OC} of 1.76 V, J_{SC} of 19.2 mA/cm² and FF of 0.70. Figure S23 and S24 shows the EQE of the individual sub-cells of the perovskite/silicon tandem and the MPP tracking of the champion tandem device for 600 s, respectively. This work represents a proof of concept that demonstrates efficient textured monolithic 2T perovskite/silicon tandem devices using slot-die coating.

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4 In summary, we systematically enhance the champion performance of slot-die
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7 coated PSCs from 18.3% in current literature to 21.8% for our champion devices, thereby
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10 bringing slot-die coated PSCs closer to the state-of-the-art spin-coated devices. Table S5
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13 compares the champion performance of slot-die coated PSCs in current literature with
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16 this work. Importantly, we make use of hydrophobic PTAA substrates for slot-die coated
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19 PSCs in the inverted *p-i-n* architecture, in contrast to slot-die PSC reported in the
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22 literature, which typically employs PEDOT:PSS as the HTL. This allowed us to reduce the
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25 performance gap between spin-coated (23%) and slot-die coated (21.8%) *p-i-n* devices.
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31 Extending our fabrication technique, we introduce the very first slot-die coated textured
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34 perovskite/silicon, 2T-monolithic tandems with a champion PCE of ~23.8%. Our results
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38 illustrate the promise of slot-die coating for scale-up of perovskite solar cells in both their
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Scheme 1. (a) The slot-die coating technique and its key parameters for a one-step controlled deposition of MAPbI₃ on ITO-PTAA substrates at 70 °C. (b) Device architecture of the planar *p-i-n* MAPbI₃ perovskite solar cell (ITO-PTAA-MAPbI₃(Cys.HCl)-C₆₀-BCP-Cu) fabricated using the slot-die coating.

Figure 1. (a) Photograph of precursor solutions composed of 1.1 M MAPbI₃ perovskite with varying acetonitrile (ACN) and methylamine (MA) in methanol (MeOH) (40% wt, commercially available) with different solvent volume ratios (10:0 to 0:10). (b) Illustration of precursor ink constituents used for the one-step slot-die coating of MAPbI₃ on PTAA substrates employed in this study. Contact-angle measurements of 1.1 M MAPbI₃ precursor solution on PTAA substrates using (c) DMF solvent with LP additive (L- α -phosphatidylcholine – 0.075% wt of MAPbI₃) (d) ACN+MA(MeOH) mixture (6:4) and (e) ACN+MA(MeOH) with LP additive (0.075% wt of MAPbI₃).

Figure 2. (a) Comparison of J - V curves of champion slot-die coated MAPbI₃ devices fabricated and optimized using ACN+MA(MeOH) solvent precursor (black),

ACN+MA(MeOH) solvent + LP additive (green) and ACN+MA(MeOH) solvent + LP additive followed by Cys.HCl surface treatment via blade coating (red). (b) J - V characteristic of the champion slot-die coated device measured with additional ARF after optimizing the deposition parameters (straight line (sphere) stands for backward scan, and dotted line (circle) depicts forward scan). (c) Distribution statistics of PCE for the corresponding devices fitted to a gaussian distribution. (d) Maximum power point tracking of the different slot-die coated devices in this study for 10 min.

Figure 3. (a) External quantum efficiency (EQE) and integrated short-circuit current-density of slot-die coated MAPbI₃ PSCs fabricated using different precursor solutions namely, ACN+MA(MeOH) (Control), ACN+MA(MeOH) + LP additive (LP), and

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4 ACN+MA(MeOH) + LP followed by Cys.HCl passivation (LP+Cys.HCl). (b) Space-charge
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7 limited current (SCLC) measurement in the dark showing the J-V traces with three
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10 different regimes of operation for slot-die coated MAPbI₃ *p-i-n* devices fabricated using
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Figure 4. (a) Device architecture schematic of perovskite/silicon tandem devices wherein the wide-bandgap perovskite absorber layer (MAPb(I_{0.75}Br_{0.25})₃ ~1.68 eV) is deposited by slot-die coating. (b) Cross-section SEM image of the textured perovskite/silicon tandem device obtained from optimized slot-die coating parameters (c) Statistics of PCE of slot-die coated tandems for different slot-die head speeds with ACN+MA(MeOH) solvent + LP

additive followed by Cys.HCl surface treatment (d) J - V curve of champion slot-die coated perovskite/silicon tandem device (inset: MPP tracking of PCE for 10 min).

ASSOCIATED CONTENT

Supporting Information. Details of material characterization, experimental section, figures described in the text, slot-die parameter optimization of devices, and literature review of the current state of slot-die coated PSCs are available in Supporting Information.

AUTHOR INFORMATION

Email address: anand.subbiah@kaust.edu.sa; stefaan.dewolf@kaust.edu.sa

Group URL: <https://kpv.kaust.edu.sa/home>

Twitter handle: @KAUST_KPVLab, @anandselvins

Notes

“The authors declare no competing financial interest.”

ACKNOWLEDGMENT

The authors acknowledge the support of the King Abdullah University of Science and Technology (KAUST) Office of Sponsored Research (OSR) under award no. KAUST OSR-CARF URF/1/3097, as well as funding support from QD Solar, Inc. The authors also thank the members of the KAUST Solar Center operations team for their valuable support. The authors also thank all the previous reports tabulated in Table S5 for the data points compiled in the TOC graphic.

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